Octal D-type flip-flop with data enable; positive-edge triggerRev. 3 — 25 September 2013Product data sheet

1. General description

The 74HC377; 74HCT377 is an octal positive-edge triggered D-type flip-flop. The device features clock (CP) and data enable (\overline{E}) inputs. When \overline{E} is LOW, the outputs Qn assume the state of their corresponding Dn inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition. Input \overline{E} must be stable one set-up time prior to the LOW-to-HIGH transition for predictable operation. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Common clock and master reset
- Eight positive edge-triggered D-type flip-flops
- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC377: CMOS level
 - ◆ For 74HCT377: TTL level
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

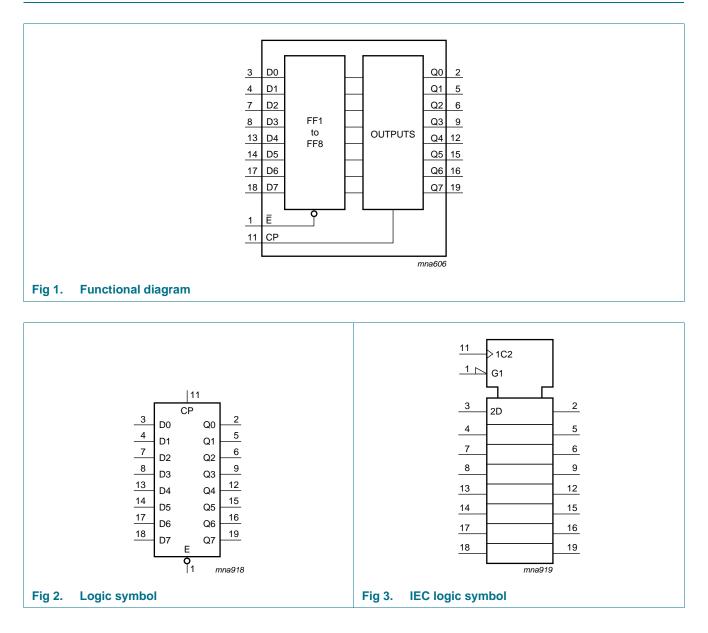
Table 1.Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC377N	–40 °C to +85 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1
74HCT377N				
74HC377D	–40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74HCT377D				
74HC377DB	–40 °C to +85 °C	SSOP20	plastic shrink small outline package; 20 leads; body width	SOT339-1
74HCT377DB			5.3 mm	
74HC377PW	–40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body	SOT360-1
74HCT377PW			width 4.4 mm	

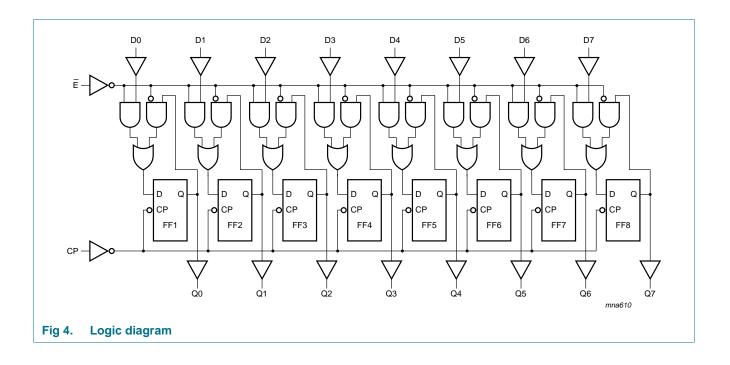


Octal D-type flip-flop with data enable; positive-edge trigger

4. Functional diagram



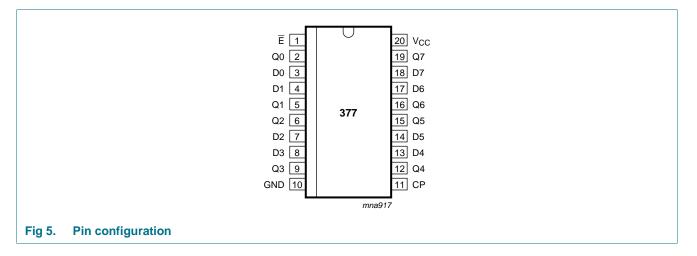
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Octal D-type flip-flop with data enable; positive-edge trigger

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.Pin description

Symbol	Pin	Description
Ē	1	data enable input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	flip-flop output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
CP	11	clock input (LOW-to-HIGH, edge triggered)
V _{CC}	20	supply voltage

6. Functional description

Table 3.Function table

Operating modes	Inputs	Outputs		
	СР	E	Dn	Qn
load "1"	\uparrow	I	h	Н
load "0"	\uparrow	I	Ι	L
hold (do nothing)	1	h	Х	no change
	Х	Н	Х	no change

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

X = don't care;

 \uparrow = LOW-to-HIGH clock transition.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> -	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> -	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
		DIP20 package	[2] _	750	mW
		SO20, SSOP20, TSSOP20	<u>[3]</u> _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For DIP20 package: above 70 °C the value of Ptot derates linearly with 12 mW/K.

[3] For SO20 package: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.

For SSOP20 and TSSOP20 packages: above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC377	7	7	4HCT37	7	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Uni
			Min	Тур	Max	Min	Мах	Min	Max	
74HC37	7						1			
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
VIL	LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu A; V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -20 \ \mu A; V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1	-	±1	μA
l _{cc}	supply current		-	-	8.0	-	80	-	160	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT3	77									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{он}	HIGH-level	$V_{I} = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5$ V								
•	output voltage	$I_0 = -20 \ \mu A$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4.0 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 5.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1	-	±1	μA

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Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$	-	-	8.0	-	80	-	160	μA
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 V$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V								
		E input	-	150	540	-	675	-	735	μA
		CP input	-	50	180	-	225	-	245	μA
		Dn input	-	20	72	-	90	-	98	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7.Dynamic characteristics

GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit, see Figure 8

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC377	7									
t _{pd}	propagation	CP to Qn; see Figure 6	1]							
	delay	$V_{CC} = 2.0 V$	-	44	160	-	200	-	240	ns
		$V_{CC} = 4.5 V$	-	16	32	-	40	-	48	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	13	-	-	-	-	-	-
		$V_{CC} = 6.0 V$	-	13	27	-	34	-	41	ns
tt	transition time	Qn output; see Figure 6	<u>2]</u>							
		$V_{CC} = 2.0 V$	-	19	75	-	95	-	110	ns
		$V_{CC} = 4.5 V$	-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$	-	6	13	-	16	-	19	ns
t _W	pulse width	CP input HIGH or LOW; see <u>Figure 6</u>								
		$V_{CC} = 2.0 V$	80	14	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$	16	5	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$	14	4	-	17	-	20	-	ns
t _{su}	set-up time	Dn to CP; see Figure 7								
		$V_{CC} = 2.0 V$	60	14	-	75	-	90	-	ns
		$V_{CC} = 4.5 V$	12	5	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	4	-	13	-	15	-	ns
		E to CP; see Figure 7								
		$V_{CC} = 2.0 V$	60	6	-	75	-	90	-	ns
		$V_{CC} = 4.5 V$	12	2	-	15	-	18	-	ns
		$V_{CC} = 6.0 V$	10	2	-	13	-	15	-	ns

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Symbol	Parameter	Conditions			25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Uni
				Min	Тур	Max	Min	Max	Min	Max	
t _h	hold time	Dn to CP; see Figure 7									
		$V_{CC} = 2.0 V$		3	-8	-	3	-	3	-	ns
		$V_{CC} = 4.5 V$		3	-3	-	3	-	3	-	ns
		$V_{CC} = 6.0 V$		3	-2	-	3	-	3	-	ns
		E to CP; see Figure 7									
		$V_{CC} = 2.0 V$		4	-3	-	4	-	4	-	ns
		$V_{CC} = 4.5 V$		4	-1	-	4	-	4	-	ns
		$V_{CC} = 6.0 V$		4	-1	-	4	-	4	-	ns
f _{max}	maximum	CP input; see Figure 6									
	frequency	$V_{CC} = 2.0 V$		6	23	-	5	-	4	-	MH
		$V_{CC} = 4.5 V$		30	70	-	24	-	20	-	MH
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	77	-	-	-	-	-	MH
		$V_{CC} = 6.0 V$		35	83	-	28	-	24	-	MH
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC}	<u>[3]</u>	-	20	-	-	-	-	-	pF
74HCT3	77										
t _{pd}		CP to Qn; see Figure 6	[1]								
	delay	$V_{CC} = 4.5 V$		-	17	32	-	40	-	48	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	14	-	-	-	-	-	ns
t _t	transition time	Qn output; see Figure 6	[2]								
		$V_{CC} = 4.5 V$		-	7	15	-	19	-	22	ns
t _W	pulse width	CP input; see Figure 6									
		$V_{CC} = 4.5 V$		20	8	-	25	-	30	-	ns
t _{su}	set-up time	Dn to CP; see Figure 7									
		$V_{CC} = 4.5 V$		12	4	-	15	-	18	-	ns
		E to CP; see Figure 7									
		$V_{CC} = 4.5 V$		22	12	-	28	-	33	-	ns
t _h	hold time	Dn to CP; see Figure 7									
		$V_{CC} = 4.5 V$		2	-4	-	2	-	2	-	ns
		E to CP; see Figure 7									
		$V_{CC} = 4.5 V$		3	-2	-	3	-	3	-	ns
f _{max}	maximum	CP input; see Figure 6									
	frequency	$V_{CC} = 4.5 V$		27	48	-	22	-	18	-	MH
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	53	-	-	-	-	-	MH

Table 7. Dynamic characteristics ...continued

GND (ground = 0 V); C_1 = 50 pF unless otherwise specified; for test circuit, see Figure 8

Octal D-type flip-flop with data enable; positive-edge trigger

Symbol	Symbol Parameter Conditions				25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} – 1.5 V	<u>[3]</u>	-	20	-	-	-	-	-	pF

Table 7. Dynamic characteristics ... continued

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

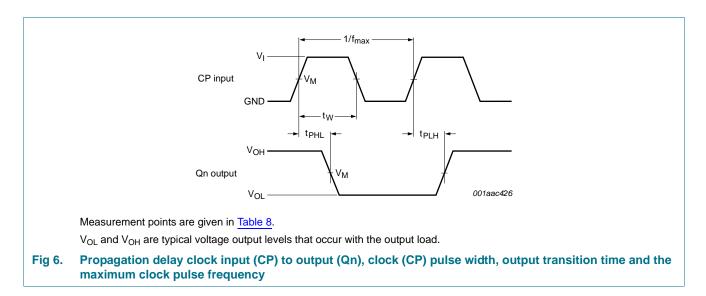
fo = output frequency in MHz;

 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs;

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V.

11. Waveforms



74HC377; 74HCT377

Octal D-type flip-flop with data enable; positive-edge trigger

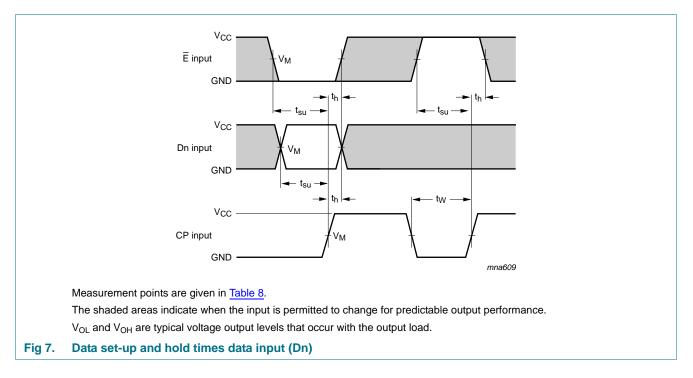


Table 8.Measurement points

Туре	Input	Output	
	VI	V _M	V _M
74HC377	V _{CC}	0.5V _{CC}	0.5V _{CC}
74HCT377	3 V	1.3 V	1.3 V

74HC377; 74HCT377

Octal D-type flip-flop with data enable; positive-edge trigger

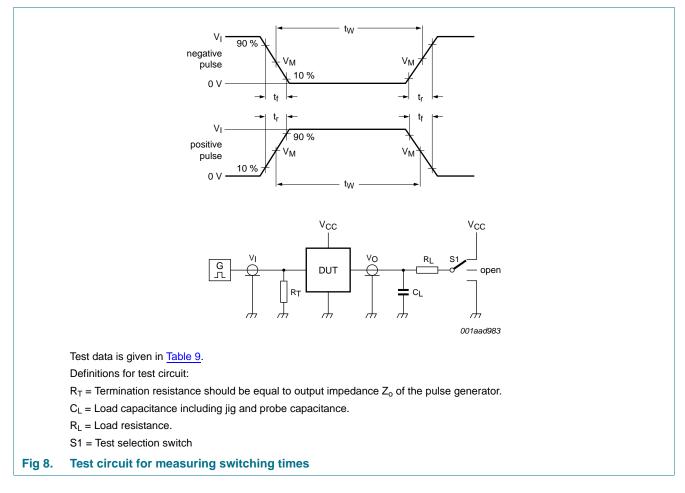


Table 9.Test data

Туре	Input		Load		S1 position	
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	
74HC377	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	
74HCT377	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	

74HC377; 74HCT377

Octal D-type flip-flop with data enable; positive-edge trigger

12. Package outline

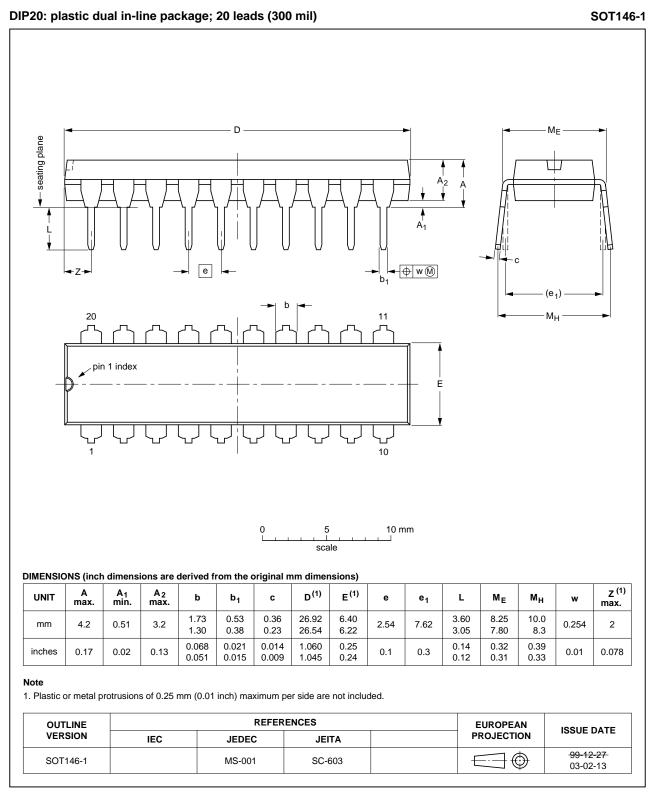


Fig 9. Package outline SOT146-1 (DIP20)

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Octal D-type flip-flop with data enable; positive-edge trigger

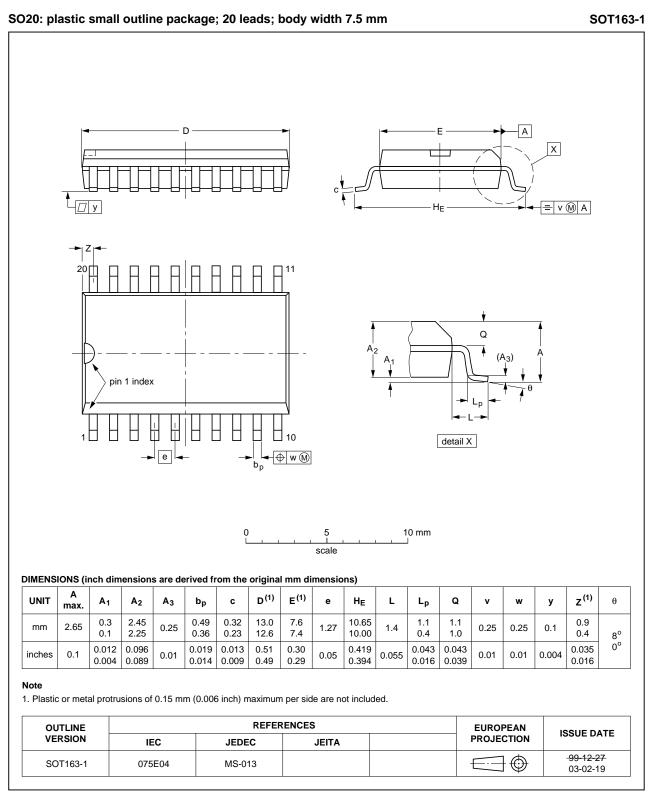


Fig 10. Package outline SOT163-1 (SO20)

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Octal D-type flip-flop with data enable; positive-edge trigger

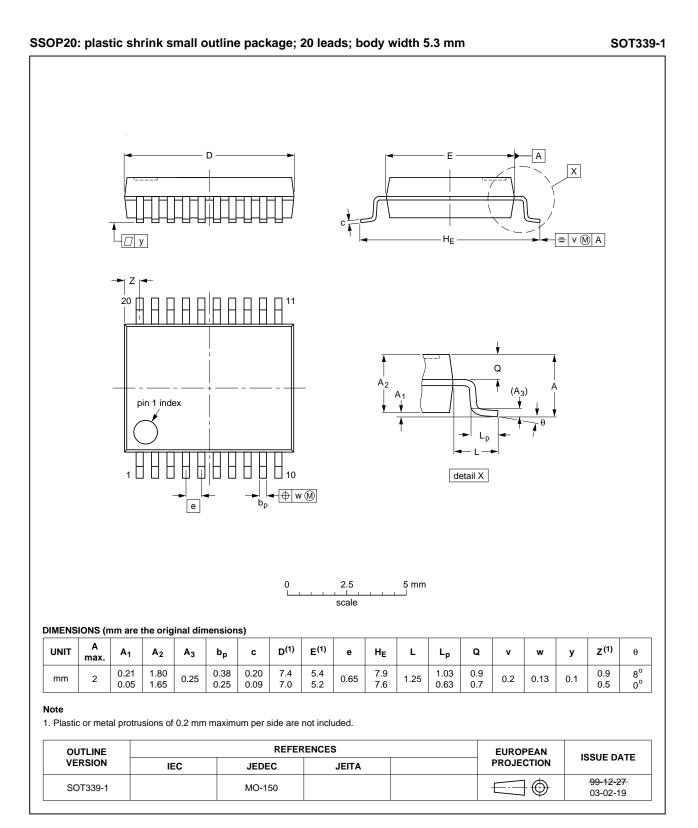


Fig 11. Package outline SOT339-1 (SSOP20)

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Octal D-type flip-flop with data enable; positive-edge trigger

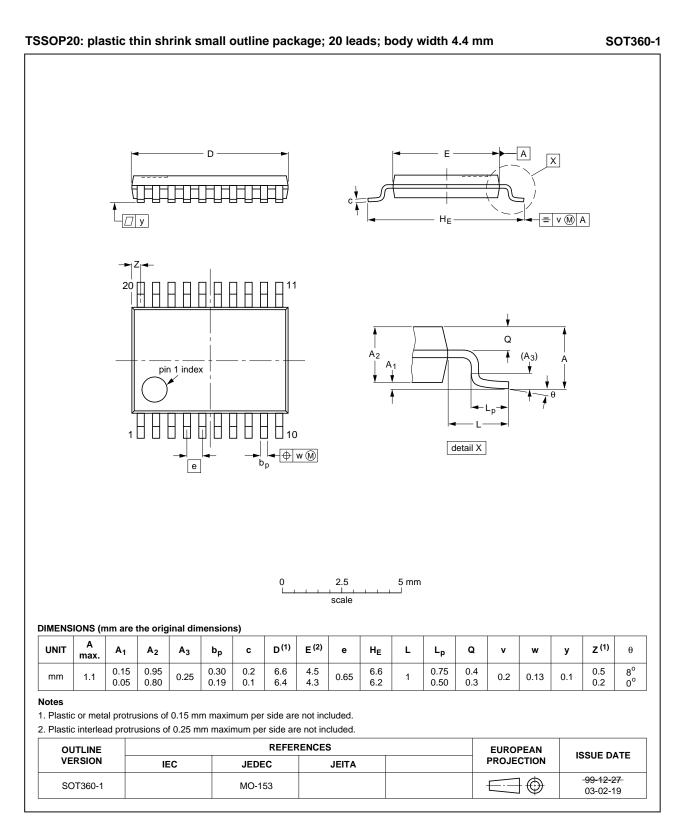


Fig 12. Package outline SOT360-1 (TSSOP20)

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Octal D-type flip-flop with data enable; positive-edge trigger

13. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT377 v.3	20130925	Product data sheet	-	74HC_HCT377_CNV v.2		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts 	have been adapted to the	ne new company name	where appropriate.		
74HC_HCT377_CNV v.2	19901227	Product specification	-	•		

Octal D-type flip-flop with data enable; positive-edge trigger

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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